

3A, 50V - 600V Ultra Fast Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Ultra fast recovery time for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- Freewheeling application

MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.210g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
I _F	3	Α			
V_{RRM}	50 - 600	V			
I _{FSM}	75	Α			
T _{J MAX}	175	°C			
Package	DO-214AB (SMC)				
Configuration	Single die				









DO-214AB (SMC)



PARAMETER	SYMBOL	MUR	MUR	MUR	MUR	MUR	MUR	UNIT
		305SH	310SH	315SH	320SH	340SH	360SH	UNII
Marking code on the device		MUR 305S	MUR 310S	MUR 315S	MUR 320S	MUR 340S	MUR 360S	
Repetitive peak reverse voltage	V_{RRM}	50	100	150	200	400	600	V
Reverse voltage, total rms value	V _{R(RMS)}	35	70	105	140	280	420	V
Forward current	I _F	3				Α		
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	75				А		
Junction temperature	T_J	- 55 to +175				°C		
Storage temperature	T _{STG}	- 55 to +175				°C		

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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction-to-lead thermal resistance	$R_{\Theta JL}$	11	°C/W		

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
	MUR305SH MUR310SH MUR315SH MUR320SH I _F = 3A, T _J = 25°C V	V _F	-	0.875	V	
Forward voltage ⁽¹⁾	MUR340SH MUR360SH			-	1.250	V
	MUR305SH MUR310SH MUR315SH MUR320SH	I _F = 3A, T _J = 150°C	V _F	-	0.710	>
	MUR340SH MUR360SH			-	1.050	٧
Reverse current @ rated V _R ⁽²⁾	MUR305SH MUR310SH MUR315SH MUR320SH	T _J = 25°C	I _R	-	5	μΑ
	MUR340SH MUR360SH			ı	10	μΑ
	MUR305SH MUR310SH MUR315SH MUR320SH	T _J = 150°C	I R	-	150	μΑ
	MUR340SH MUR360SH			-	250	μΑ
Reverse recovery time	MUR305SH MUR310SH MUR315SH MUR320SH	$I_F = 0.5A, I_R = 1.0A$ $I_{rr} = 0.25A$	t _{rr}	-	25	ns
	MUR340SH MUR360SH	1 _{rr} = 0.23A		-	50	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE(1)	PACKAGE	PACKING			
MUR3xSH	DO-214AB (SMC)	3,000 / Tape & Reel			

Notes:

1. "x" defines voltage from 50V(MUR305SH) to 600V(MUR360SH)



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

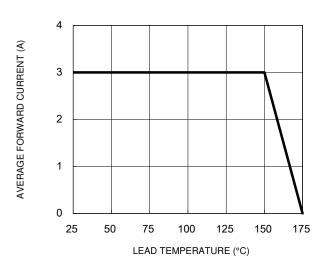


Fig.3 Typical Reverse Characteristics

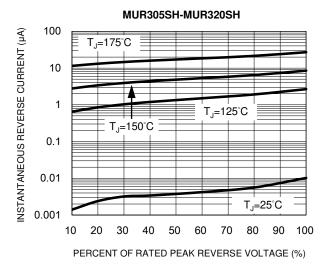


Fig.5 Typical Reverse Characteristics

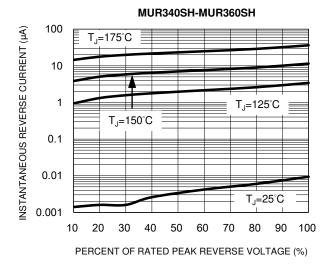


Fig.2 Typical Junction Capacitance

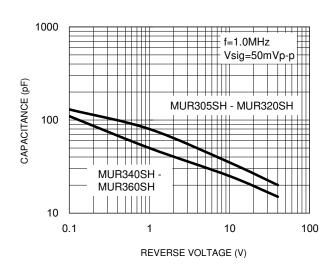


Fig.4 Typical Forward Characteristics

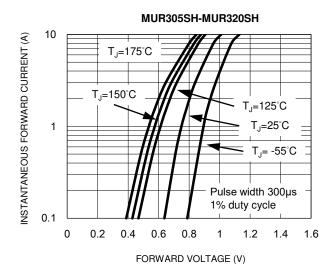
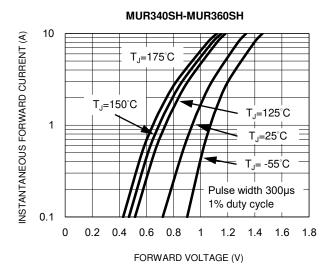


Fig.6 Typical Forward Characteristics



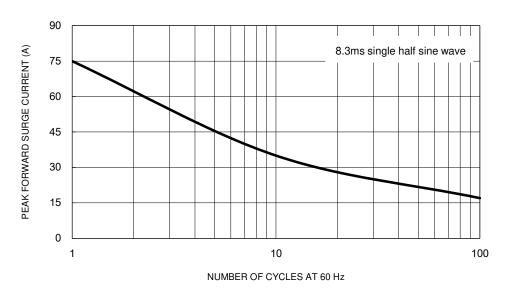
Wersion: B2212



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

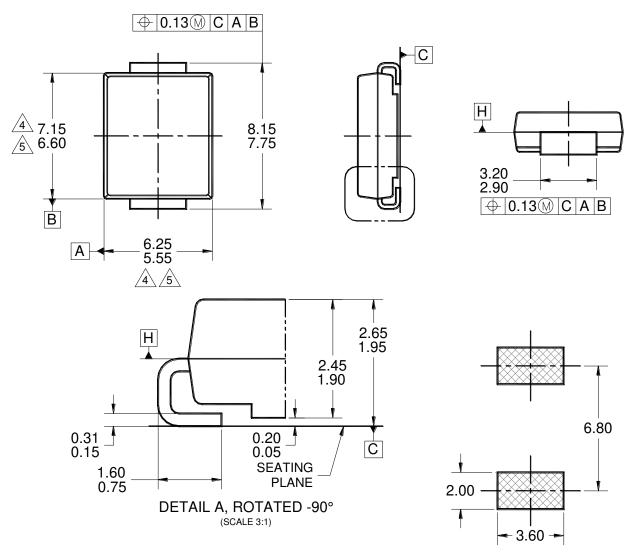
Fig.7 Maximum Non-Repetitive Forward Surge Current

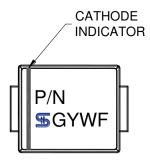




PACKAGE OUTLINE DIMENSIONS

DO-214AB (SMC)





MARKING DIAGRAM

P/N = MARKING CODE
G = GREEN COMPOUND

YW = DATE CODE F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.

SUGGESTED PAD LAYOUT

- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AB, ISSUE D.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
 - 6. DWG NO. REF: HQ2SD07-DO214SMC-036 REV A.



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